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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	3120
Total RAM Bits	36864
Number of I/O	212
Number of Gates	125000
Voltage - Supply	1.14V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	289-TFBGA, CSBGA
Supplier Device Package	289-CSP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/aglp125v2-cs289">https://www.e-xfl.com/product-detail/microchip-technology/aglp125v2-cs289</a>

## Temperature Grade Offerings

Package	AGLP030	AGLP060	AGLP125
CS201	C, I	C, I	—
CS281	—	—	C, I
CS289	C, I	C, I	C, I
VQ128	C, I	—	—
VQ176	—	C, I	—

**Notes:**

1. C = Commercial temperature range: 0°C to 85°C junction temperature.
2. I = Industrial temperature range: -40°C to 100°C junction temperature.

Contact your local Microsemi SoC Products Group representative for device availability:

<http://www.microsemi.com/soc/company/contact/default.aspx>.

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